

CLASS 2 BOARD PROPOSED ON: 05/28/2010

			GND5 ONLY											
1	copper	0.0005	.008 hole 1-2 u .016 pad	.008 hole 1-3u .016 pad						SURFACE				
	dielectric	0.003												
2	copper	0.0005												GND /PWR PLANE
	dielectric	0.004												
3	copper	0.0007			.008 hole 1-5u .016 pad	.008 hole 1 thru 7 .016 pad	.008 hole 1 thru 9 .016 pad	.008 hole 1 thru 10 .016 pad	.008 hole 1 thru 20 .016 pad	Pair Layer (3.5trace---5.5 space)				
	dielectric	0.005												
4	copper	0.0007								GND /PWR PLANE				
	dielectric	0.004												
5	copper	0.0007								Pair Layer (3.5trace---5.5 space)				
	dielectric	0.005												
6	copper	0.0005								GND /PWR PLANE				
	dielectric	0.005												
7	copper	0.0005								Pair Layer (3.5trace---5.5 space)				
	dielectric	0.006												
8	copper	0.0005								GND /PWR PLANE				
	dielectric	0.005												
9	copper	0.0005								Pair Layer (3.5trace---5.5 space)				
	dielectric	0.006												
10	copper	0.0005								GND /PWR PLANE				
	dielectric	0.006												
11	copper	0.0005								GND /PWR PLANE				
	dielectric	0.006												
12	copper	0.0007								Pair Layer (3.5trace---5.5 space)				
	dielectric	0.006												
13	copper	0.0007								GND /PWR PLANE				
	dielectric	0.005												
14	copper	0.0007								Pair Layer (3.5trace---5.5 space)				
	dielectric	0.005												
15	copper	0.0007								GND /PWR PLANE				
	dielectric	0.004												
16	copper	0.0007								Pair Layer (3.5trace---5.5 space)				
	dielectric	0.004												
17	copper	0.0007						.008 hole 9 thru 20 .016 pad		GND /PWR PLANE				
	dielectric	0.005												
18	copper	0.0007								Pair Layer (3.5trace---5.5 space)				
	dielectric	0.004												
19	copper	0.0005								GND /PWR PLANE				
	dielectric	0.003												
20	copper	0.0005								SURFACE/GND				

thk

0.107

0.004 ***plus plating (.001)x4 places on lyrs 2, 6, 7, 11